## THROUGH-HOLE MICRO HEADER

(1.27 mm) .050" PITCH • FTSH SERIES



**FTSH Board Mates:** CLP, FLE

Cable Mates:

FFSD, FFTP

#### **SPECIFICATIONS**

Insulator Material: Black Liquid Crystal Polymer Terminal Material: Phosphor Bronze Plating: Sn or Au over 50 µ" (1.27 µm) Ni Current Rating (FTSH/CLP): 3.4 A per pin (2 pins powered) Operating Temp Range: -55 °C to +125 °C

#### **PROCESSING**

Lead-Free Solderable:

#### **LOCKING CLIP**

For single mating cycle with the FFSD. PC BOARD □ 00000 Specify -LC after tail option. Lead Style -01 and 10 pins/row minimum. 5-9 pins/row not available in combination with keying shroud (-K).

### ALSO AVAILABLE MOQ Required

Molded Pick & Place pads Other platings



#### Notes:

Some sizes, styles and options are non-standard, non-returnable.

See SFM/TFM for positive alignment feature.



02

thru

50

Specify LEAD **STYLE** from

LEAD

STYLE

chart

= Gold flash on post, Matte Tin on tail

**PLATING** 

**OPTION** 

-L = 10 µ" (0.25 µm) Gold on post, Matte Tin on tail

Leave blank for Right-angle

OPTION

-"XXX" = Polarized Position (Specify position of omitted pin) (Not available with -EX options)

Leave blank for straight tail

TAIL

OPTION

-RA = Right-angle

**-ES** = End Shroud (Style -02 & -03)

**OPTIONS** 

9 pins/row minimum -EP

End Shroud with Guide Post (Style –02 & –03) 9 pins/row minimum

-EL = End Shroud with Board Lock (Style -02 & -03) 9 pins/row

–EJ = Ejector Shroud (Style –01 only) 10 pins/row minimum 25 pins/row maximum –RA not available

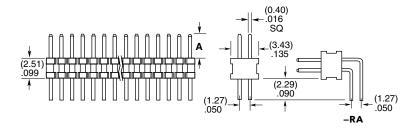
-K = Keying Shroud for mating with FFSD (Style –01 only, 05 thru 25 pins/row only. 13, 17, 20 & 25 only with -EJ option)

# — No. of positions x (1.27) .050 + Z→

-EX OPTION SHOWN

→ No of positions v (1.27) 050→	
No. of positions x (1.27) .050 →	<u> </u>
0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	43)
	35
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OPTION	z
-ES	(1.55) .061
–EJ	(15.77) .621
–EP (5.87) .231	
-EL	((6.53) .257



LEAD STYLE	A	MATES WITH
-01	(3.05) .120	FFSD
-02	(1.91) .075	FLE
-03	(1.65) .065	CLP-D
-04	(3.81)	N/A

